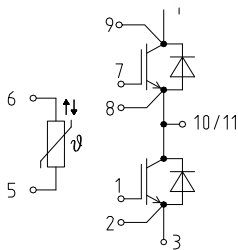
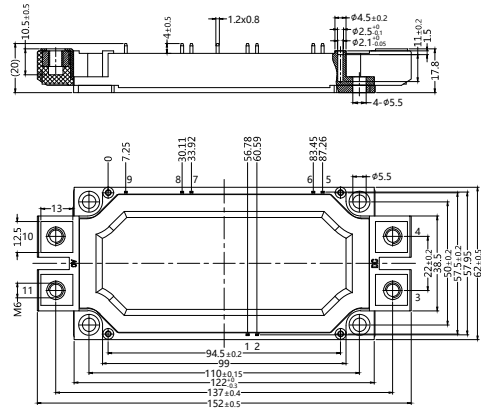


SGG600T170UC5

IGBT Modules



Dimensions in mm (1mm = 0.0394")



$T_c = 25^\circ\text{C}$, unless otherwise specified

Symbol	Conditions	Values	Units
IGBT			
V_{CES}		1700	V
I_C	$T_C = 100^\circ\text{C}$	600	A
I_{CRM}	$T_C = 25^\circ\text{C}$, $t_p = 1\text{ms}$	1200	A
V_{GES}		± 20	V
T_{vj}		$-40 \dots +175$	$^\circ\text{C}$
Inverse Diode			
$I_F = -I_C$	$T_C = 100^\circ\text{C}$	600	A
I_{FRM}	$T_C = 25^\circ\text{C}$, $t_p = 1\text{ms}$	1200	A
I_{FSM}	$t_p = 10\text{ms}$; sin.; $T_j = 150^\circ\text{C}$	1200	A
Module			
$I_{t(RMS)}$	$T_{teminal} = 100^\circ\text{C}$	600	A
T_{stg}		$-40 \sim 125$	$^\circ\text{C}$
V_{Isol}	AC, 1min	4000	V
P_{tot}	$T_C = 25^\circ\text{C}$, $T_{vj} \text{ max} = 175^\circ\text{C}$	2500	W

Features

- Trench Field Stop IGBT technology
- Low switching losses
- Switching frequency upto 20KHz
- Square RBSOA, no latch up
- High short circuit capability
- Positive temperature coefficient for easy paralleling
- MOS input, voltage controlled
- Ultra fast free wheeling diodes
- Package with copper baseplate
- Isolation voltage 4000V

Application

- AC and DC motor control
- AC servo and robot drives
- power supplies
- welding inverters

Advantages

- space and weight savings
- reduced protection circuits

SGG600T170UC5

IGBT Modules

Characteristics

T_C = 25°C, unless otherwise specified

Symbol	Conditions	min.	typ.	max.	Units
IGBT					
V _{GE(th)}	V _{GE} = V _{CE} , I _C = 24mA	5.0	5.8	6.5	V
I _{CES}	V _{GE} = 0; V _{CE} = V _{CES} ; T _J = 25°C			1.0	mA
V _{CE(TO)}	T _J = 25°C		0.82	0.92	V
r _{CE}	V _{GE} = 15V, T _J = 25(125)°C		3.40(5.10)	3.90(5.40)	mΩ
V _{CE(sat)}	I _C = 600A; V _{GE} = 15V; chip level		1.90	2.25	V
C _{ies}	under following conditions V _{GE} = 0, V _{CE} = 25V, f = 1MHz		64.00		nF
C _{oes}			2.30		
C _{res}			3.08		
L _{CE}				20	nH
R _{CC+EE'}	res., terminal-chip T _C = 25(125)°C		1.4(1.75)		mΩ
t _{d(on)}	under following conditions: V _{CC} = 900V, I _C = 450A R _{Gon} = R _{Goff} = 3Ω, T _J = 125°C V _{GE} = ± 15V		250		ns
t _r			108		ns
t _{d(off)}			610		ns
t _f			510		ns
E _{on} (E _{off})			133(118)		mJ
InverseDiode under following conditions:					
V _F = V _{EC}	I _F = 450A; V _{GE} = 0V; T _J = 25°C		2.40	2.92	V
V _(FO)	T _J = 25°C		1.40	1.60	V
r _F	T _J = 25°C		3.6	3.9	mΩ
I _{RRM}	I _F = 450A; T _J = 125°C		230		A
Q _{rr}	di/dt = 3300A/us		80		uC
E _{rr}	V _{GE} = ±15V		43		mJ
Thermal Characteristics					
R _{th(j-c)}	per IGBT			0.094	K/W
R _{th(j-c)D}	per Inverse Diode			0.150	K/W
R _{th(c-s)}	per module			0.011	K/W
Mechanical Data					
M _s	to heatsink M5	3		6	Nm
M _t	to terminals M6	3		6	Nm
Weight	typical			350	g
Temperature Sensor					
R ₁₀₀	T _C = 100°C (R ₂₅ = 5 kΩ)		493 ± 5%		Ω
B _{100/125}	R(T) = R ₁₀₀ exp[B _{100/125} (1/T - 1/T ₁₀₀)]; T[K];		3550 ± 2%		K

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IGBT Modules

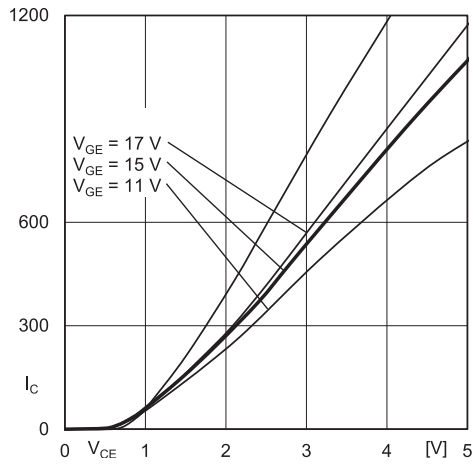


Fig. 1: Typ. output characteristic, inclusive $R_{CC} + EE'$

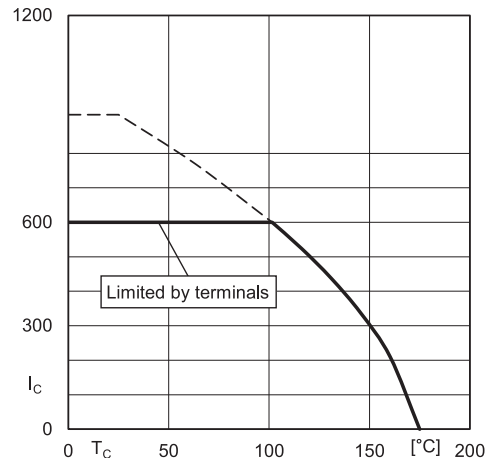


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

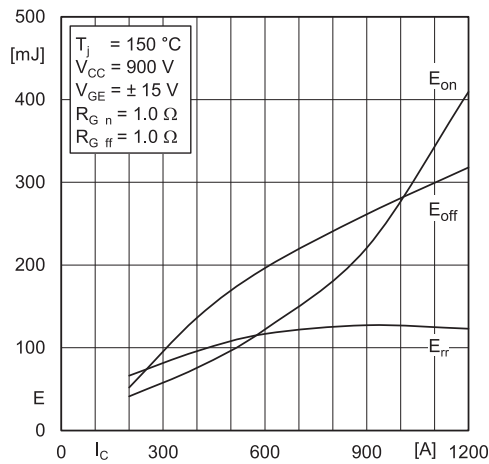


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

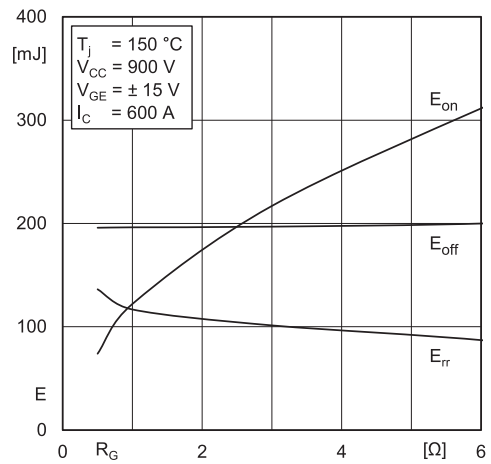


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

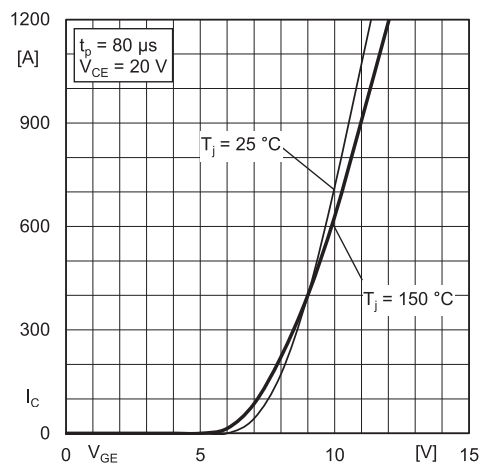


Fig. 5: Typ. transfer characteristic

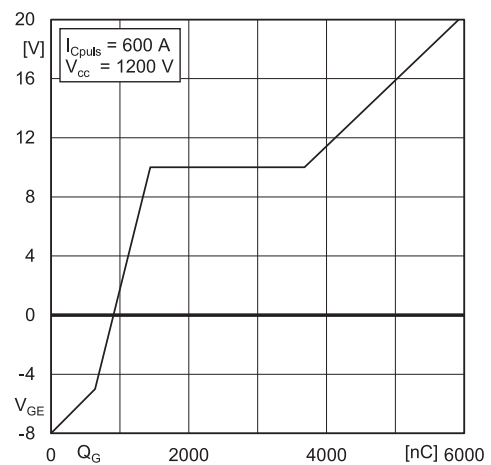


Fig. 6: Typ. gate charge characteristic

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IGBT Modules

